



GLASS PASSIVATED BRIDGE RECTIFIERS

REVERSE VOLTAGE – FORWARD CURRENT –

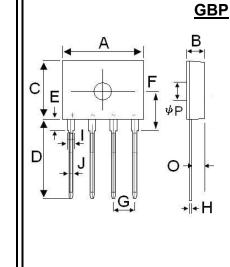
1000 Volts 8.0 Amperes

FEATURES

- Rating to 1000V PRV
- Ideal for printed circuit board
- Reliable construction utilizing molded plastic technique
- UL recognized file # E95060

MECHANICAL DATA

- Case Material: "Green" molding compound, UL flammability classification 94V-0, (No Br. Sb. Cl)
- Polarity indicator: As marked on body
- Weight: 1.33 grams



	GBP		
Dim.	Min.	Max.	
Α	14.2	14.7	
В	2.90	3.30	
С	10.1	10.7	
D	13.8	14.4	
E	1.80	2.20	
F	6.65	7.25	
G	3.71	3.91	
Н	0.40	0.60	
I	1.20	1.40	
J	0.64	0.84	
0	1.80	2.40	
Р	3.1ψ	3.3ψ	
All Dimensions in millimeter			

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS Ratings at 25°C ambient temperature unless otherwise specified.

ABSOLUTE RATINGS

PARAMETER		SYMBOL	VALUE	UNIT
Maximum repetitive peak reverse voltage		V _{RRM}	1000	V
Maximum average forward rectified current @ T _A =25°C	with heat-sink without heat-sink	I _(AV)	8 1.9	A
Peak forward surge current single half sine-wave superimposed on rated load. @ $T_J=25^{\circ}C$	@8.3ms @1.0ms	I _{FSM}	165 330	А
I ² t rating for fusing (t = 8.3ms)		l ² t	112.9	A ² S
Operation and storage temperature range		T _J ,T _{STG}	-55 to +150	°C

STATIC ELECTRICAL CHARACTERISTICS

PARAMETER	TEST CO	NDITIONS	SYMBOL	MAX.	UNIT
Forward voltage	IF=4.0 A	T _J =25°C	VF	1.0	V
Leakage current	VR=1000 V	TJ=25°C TJ=125°C	I _R	1.0 100	uA
Typical junction capacitance (Note1)			CJ	45	pF

THERMAL CHARACTERISTICS

THERMAL CHARACTERISTIC	SYMBOL	TYP.	UNIT
Typical thermal resistance (without heatsink)	RthJ _C RthJ∟ RthJ _A	13 17 35	°C/W
Typical thermal resistance (with heatsink)(Note4)	RthJ _C RthJ _L RthJ _A	3 6 8	°C/W
Note :			REV-1, Sept-2021, KBDG14

(1) Perform static test after the temperature of oven is steady 20 minutes.

(2) Measured at 1.0MHz and applied reverse voltage of 4.0V DC

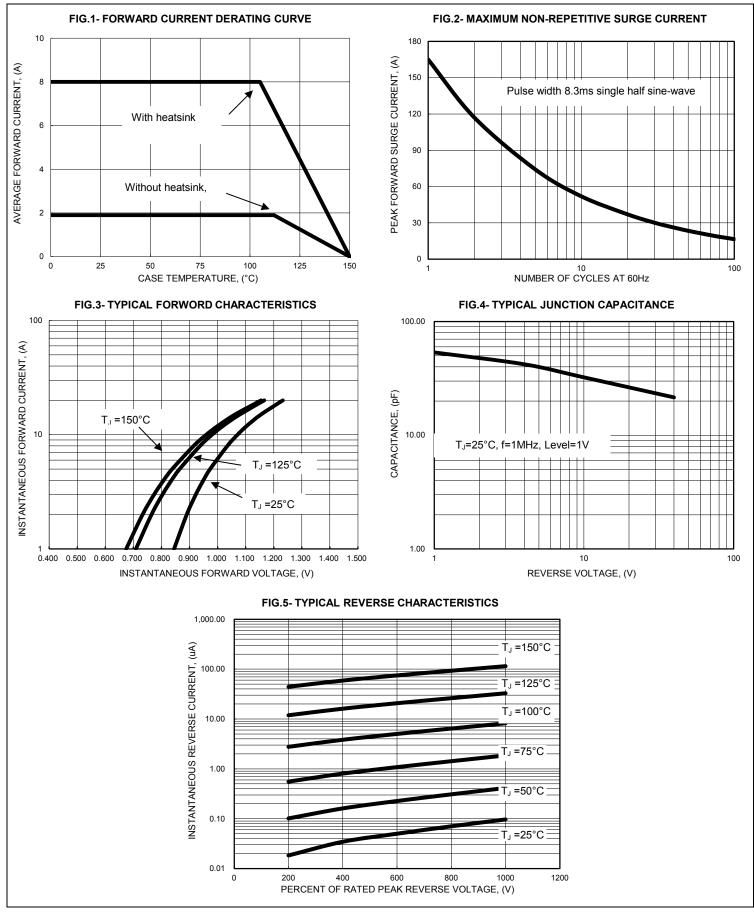
(3) Thermal resistance junction to case, lead and ambient in accordance with JESD-51.

(4) Unit mounted on attached copper pad 200mm * 200mm * 7mm fin type heatsink.



LITE-ON SEMICONDUCTOR

RATING AND CHARACTERISTIC CURVES GBP810(LS)

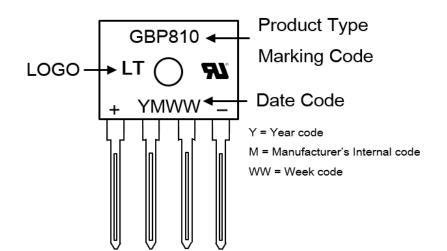




Ordering Information :

Part Number	Case	Packaging
GBP810_HF	GBP	35 Pieces/Tube

Marking Information :





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